

PATENT ASSIGNMENT COVER SHEET

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 Stylesheet Version v1.2

EPAS ID: PAT3989897

SUBMISSION TYPE:	NEW ASSIGNMENT	
NATURE OF CONVEYANCE:	ASSIGNMENT	
CONVEYING PARTY DATA		
	Name	Execution Date
	RUSTEM F. ISMAGILOV	10/20/2011
	WENBIN DU	10/31/2011
	LIANG LI	10/18/2011
	FENG SHEN	10/18/2011
	KEVIN PAUL FLOOD NICHOLS	10/24/2011
	DELAI CHEN	10/18/2011
	JASON EUGENE KREUTZ	10/18/2011
RECEIVING PARTY DATA		
Name:	UNIVERSITY OF CHICAGO	
Street Address:	5801 SOUTH ELLIS AVENUE	
City:	CHICAGO	
State/Country:	ILLINOIS	
Postal Code:	60637	
PROPERTY NUMBERS Total: 1		
	Property Type	Number
	Application Number:	15164788
CORRESPONDENCE DATA		
Fax Number:	(650)938-5200	
<i>Correspondence will be sent to the e-mail address first; if that is unsuccessful, it will be sent using a fax number, if provided; if that is unsuccessful, it will be sent via US Mail.</i>		
Phone:	(650) 335-7624	
Email:	asanchez@fenwick.com	
Correspondent Name:	DANIEL G. STODDARD	
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ATTORNEY DOCKET NUMBER:	33315	
NAME OF SUBMITTER:	DANIEL G. STODDARD, REG. NO. 69,146	
SIGNATURE:	/Daniel G. Stoddard/	
DATE SIGNED:	08/02/2016	

PATENT

Total Attachments: 9

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ASSIGNMENT

Pursuant to our obligation to The University of Chicago (hereinafter referred to as "Assignee"), an Illinois not for profit corporation having its principal place of business at 5801 South Ellis Avenue, Chicago, Illinois 60637, and for other valuable and sufficient consideration, receipt whereof is hereby acknowledged, we:

Rustem F. Ismagilov
5825 S. Dorchester Ave., Apt 10W
Chicago, IL 60637

Wenbin Du
1645 E. 50th Street, Apt. 8K
Chicago, IL 60615

Liang Li
555 Woodhaven Dr.
Mundelein, IL 60060

Feng Shen
2851 S. King Drive., Apt. 1314
Chicago, IL 60616

Kevin Paul Flood Nichols
127 N. Taylor Ave.
Oak Park, IL 60302

Delai Chen
599 Cambridge St., Apt. 402
Cambridge, MA 02141

Jason Eugene Kreutz
830 E. Hyde Park Bld., Unit 3
Chicago, IL 60615

confirm our obligation to and hereby sell, assign and convey, unto Assignee, its successors and assigns, our entire right, title and interest -

(1) in and to an invention entitled SLIP CHIP DEVICE AND METHODS for which a United States Non-Provisional Application was filed on September 20, 2011, as

Application Serial Number 13/257,811, and claims the benefit of priority of PCT International Application Serial Number PCT/US2010/028316, filed March 23, 2010, and claims the benefit of priority of United States Provisional Application Serial Number 61/162,922, filed March 24, 2009;

(2) in and to said United States patent application, in and to all other patent applications (including divisional, continuation, continuation-in-part, §111(b) provisional, §111(a), and reissue applications) based upon said invention, and in and to the patent or patents to be granted thereon, including reissues thereof, if any, to the full end of the term or terms for which said patent or patents may be granted; The effective date of this assignment is March 24, 2009;

(3) in and to all patent applications on said invention now or hereafter filed in countries foreign to the United States of America, and in and to any and all patents granted on said applications to the full end of the terms for which said patents may be granted; and

(4) under the International Convention in respect to the United States patent application and agree that any patent applications of any foreign countries which may be filed shall be filed in the name of my Assignee with a claim to priority based on said United States application.

And we hereby agree that we will, upon request of Assignee, its successors or assigns, and without further consideration to us, execute any and all papers that may be necessary, or deemed by Assignee, its successors or assigns, to be necessary, to a complete fulfillment of the intent and purposes of this Assignment, it being understood that any expense incident to the execution of such papers shall be paid by Assignee, its successors and assigns, and not by us.

And the Commissioner of Patents and Trademarks of the United States is hereby authorized and requested to issue said United States patent or patents to Assignee.

10/20/11
Date

10/19/11
Date

Date

Date

Date

Date

Date

Date

Rustem Alh
Rustem Ismagilov

Witness Signature

Bridget Samuels
Witness Printed Name

Wenbin Du

Witness Signature

Witness Printed Name

Liang Li

Witness Signature

Witness Printed Name

Feng Shen

Witness Signature

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Chicago, IL 60615

Wenbin Du
Department of Chemistry
Renmin University of China
No. 59 Zhongguancun St., Youth Apt. 7102
Haidian District, Beijing, 100872, China

confirm our obligation to and hereby sell, assign and convey, unto Assignee, its successors and assigns, our entire right, title and interest -

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Date

Rustem Ismagilov

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Wenbin Du
Wenbin Du

10/31/2011
Date

Dongyang Cai
Witness Signature

Dongyang Cai
Witness Printed Name

Date

Liang Li

Date

Witness Signature

Witness Printed Name

Date

Feng Shen

Date

Witness Signature

Witness Printed Name

Date

Rustem Ismagilov

Date

Witness Signature

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Date

Wenbin Du

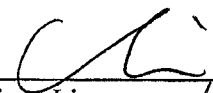
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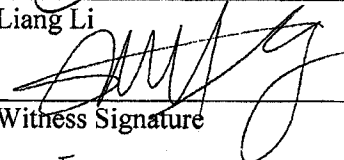
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Liang Li

10/18/11

Date



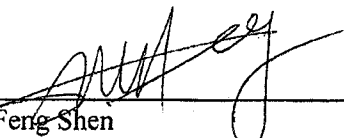
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Feng Shen

Witness Printed Name

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Date



Feng Shen

10/18/11

Date

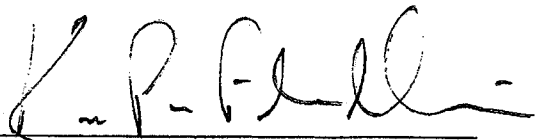


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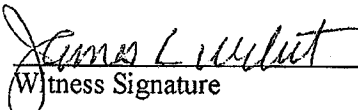
Liang Li

Witness Printed Name

10/24/11
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Kevin Paul Flood Nichols

10/24/11
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Witness Signature

James L. Willitt
Witness Printed Name

Date

Delai Chen

Date

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Jason Eugene Kreutz

Date

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Kevin Paul Flood Nichols

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Delai Chen

Witness Signature

Witness Printed Name

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Jason Eugene Kreutz

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Witness Signature

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Date

Kevin Paul Flood Nichols

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Witness Signature

Witness Printed Name

Date

Delai Chen

Date

Witness Signature

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10/18/11

Jason Eugene Kreutz

Date

10/18/2011

Witness Signature

Rebecca Kreutz
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